

MOS FIELD EFFECT TRANSISTOR 2SJ358

P-CHANNEL MOS FET FOR HIGH-SPEED SWITCH

The 2SJ358 is a P-channel vertical MOS FET that can be used as a switching element. The 2SJ358 can be directly driven by an IC operating at 5 V.

The 2SJ358 features a low on-resistance and excellent switching characteristics, and is suitable for applications such as actuator driver and DC/DC converter.

FEATURES

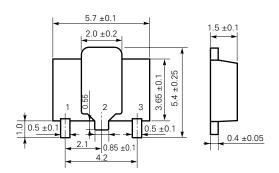
- New-type compact package
 Has advantages of packages for small signals and for power transistors, and compensates those disadvantages
- · Can be directly driven by an IC operating at 5 V.
- · Low on-resistance

RDS(ON) = 0.40 Ω MAX. @VGS = -4 V, ID = -1.5 A RDS(ON) = 0.30 Ω MAX. @VGS = -10 V, ID = -1.5 A

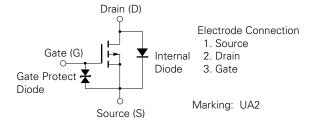
QUALITY GRADE

Standard

Package Drawings (unit: mm)



Equivalent Circuit



Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = +25 °C)

Parameter	Symbol	Conditions	Ratings	Unit
Drain-Source Voltage	V _{DSS}	V _{GS} = 0	-60	V
Gate-Source Voltage	Vgss	V _{DS} = 0	-20/+10	V
Drain Current (DC)	I _{D(DC)}		-/+3.0	А
Drain Current (Pulse)	D(pulse)	PW ≤ 10 ms Duty Cycle ≤ 1 %	-/+6.0	А
Total Power Loss	P _T	Mounted on ceramic board of 7.5 cm ² × 0.7 mm	2.0	W
Channel Temperature	Tch		150	°C
Storage Temperature	T _{stg}		-55 to +150	°C

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

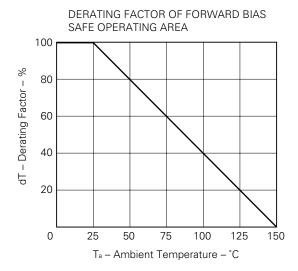
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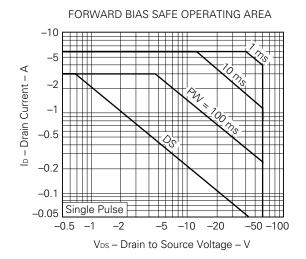


ELECTRICAL SPECIFICATIONS (Ta = +25 °C)

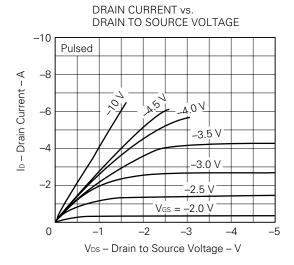
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Drain Shut-down Current	Ipss	V _{DS} = -60 V, V _{GS} = 0			-10	μΑ
Gate Leak Current	Igss	Vgs = -16/+10 V, Vps = 0			-/+10	μΑ
Gate Cutoff Voltage	V _{GS(off)}	V _{DS} = −10 V, I _D = −1 mA	-1.0	-1.4	-2.0	٧
Forward Transfer Admittance	lyfsl	V _{DS} = −10 V, I _D = −1.0 A	1.8			S
Drain-Source On-Resistance	RDS(on)1	V _G S = −4 V, I _D = −1.5 A		0.29	0.40	Ω
Drain-Source On-Resistance	RDS(on)2	Vgs = −10 V, ID = −1.5 A		0.18	0.30	Ω
Input Capacitance	Ciss	$V_{DS} = -10 \text{ V, } V_{GS} = 0,$		600		pF
Output Capacitance	Coss	f = 1.0 MHz		300		pF
Feedback Capacitance	Crss			120		pF
On-Time Delay	td(on)	$V_{DD} = -25 \text{ V, } I_{D} = -1.5 \text{ A}$ $V_{GS(on)} = -10 \text{ V}$ $R_{G} = 10 \Omega, R_{L} = 17 \Omega$		6		ns
Rise Time	tr			35		ns
Off-Time Delay	td(off)			155		ns
Fall Time	tf			95		ns
Gate Input Charge	Q _G	V _{DS} = −48 V,		23.9		nC
Gate-Source Chanrge	Qgs	$V_{GS} = -10 \text{ V},$ $I_{D} = -3.1 \text{ A}, I_{G} = -2 \text{ mA}$		1.5		nC
Gate-Drain Charge	QgD			8.1		nC
Internal Diode Reverse Recovery Time	trr	I _F = 3.0 A di/dt = 50 A/μs		95		ns
Internal Diode Reverse Recovery Charge	Qrr			118		nC

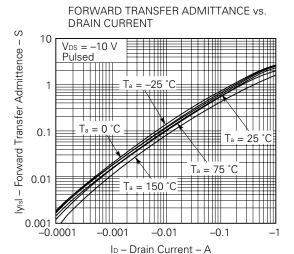
CHARACTERISTICS CURVES (Ta = +25 °C)

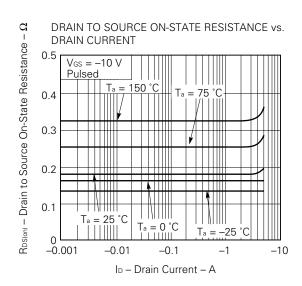




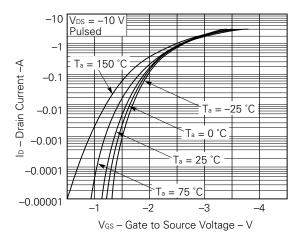




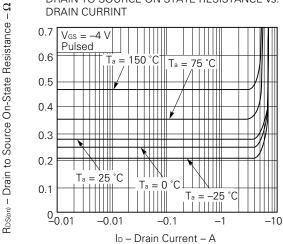




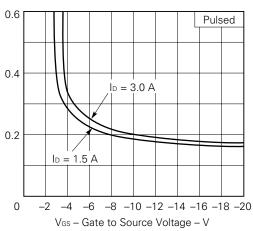




DRAIN TO SOURCE ON-STATE RESISTANCE vs. **DRAIN CURRINT**

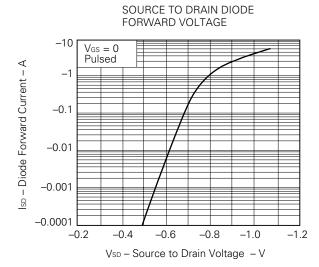


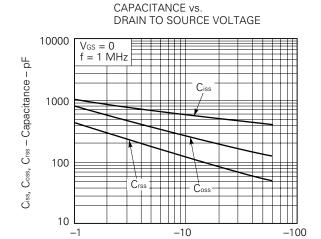
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



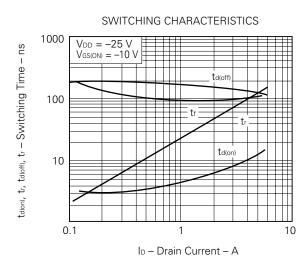
 $\ensuremath{\mathsf{Abs}}_\text{lonl}$ – Drain to Source On-State Resistance – Ω

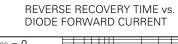


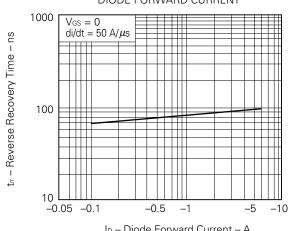




V_{DS} - Drain to Source Voltage - V

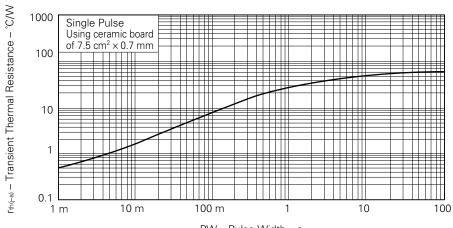






ID - Diode Forward Current - A

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



PW - Pulse Width - s



RELATED DOCUMENTS

Document Name	Document No.		
Semiconductor Device Mounting Technology Manual	IEI-1207		
NEC Semiconductor Device Reliability/Quality Control System	TEI-1202		
Guide to Quality Assurance for Semiconductor Device	MEI-1202		

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